OSRAM LB Y8SG **Datasheet**

Discontinued





Micro SIDELED® 3010

LB Y8SG

Micro SIDELED is a SMT LED with side emission. Due to its low package height it is ideal for applications in limited space environments.









Applications

- Access Control & Security
- Appliances & Tools
- Computing
- Display Backlighting
- Factory Automation
- Home & Building Automation

- Material Processing
- Projection & Display
- Robotics
- Smart Surface
- Visualization

Features

- Package: white SMT package, colorless clear resin
- Chip technology: ThinGaN
- Typ. Radiation: 120° (Lambertian emitter)
- Color: λ_{dom} = 470 nm (• blue)
- Optical efficacy: 21 lm/W
- Corrosion Robustness Class: 1B



Ordering Information

Type Luminous Intensity $^{1)}$ Ordering Code $I_F = 20 \text{ mA}$

I_F – 20 I

LB Y8SG-T1U2-35-1 280 ... 710 mcd Q65110A8976

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Maximum Ratings			
Parameter	Symbol		Values
Operating Temperature	T _{op}	min. max.	-40 °C 110 °C
Storage Temperature	T_{stg}	min. max.	-40 °C 110 °C
Junction Temperature	T _j	max.	125 °C
Forward current T _A = 25 °C	I _F	min. max.	5 mA 30 mA
Surge current t \leq 10 µs; D = 0.005 ; T _A = 25 °C	I _{FS}	max.	300 mA
Reverse voltage ²⁾ T _A = 25 °C	V_R	max.	5 V
ESD withstand voltage acc. ANSI/ESDA/JEDEC JS-001 (HBM, Class 0)	V_{ESD}	ES	SD sensitive device

Characteristics

 $I_F = 20 \text{ mA}; T_A = 25 \text{ }^{\circ}\text{C}$

Parameter	Symbol		Values
Dominant Wavelength ³⁾ I _F = 20 mA	$\lambda_{\sf dom}$	min. typ. max.	464 nm 470 nm 476 nm
Spectral Bandwidth at 50% I _{rel,max}	Δλ	typ.	25 nm
Viewing angle at 50% I _v	2φ	typ.	120 °
Forward Voltage ⁴⁾ I _F = 20 mA	$V_{_{\rm F}}$	min. typ. max.	2.90 V 3.20 V 3.70 V
Reverse current ²⁾ V _R = 5 V	I _R	typ. max.	0.01 μA 10 μA
Real thermal resistance junction/ambient 5)6)	$R_{thJA\ real}$	max.	540 K / W
Real thermal resistance junction/solderpoint 5)	R _{thJS real}	max.	320 K / W



Brightness Groups

Group	Luminous Intensity 1) I _F = 20 mA	Luminous Intensity. 1) I _F = 20 mA	Luminous Flux ⁷⁾ I _F = 20 mA
	min.	max.	typ.
	l _v	l _v	Φ _V
T1	280 mcd	355 mcd	950 mlm
T2	355 mcd	450 mcd	1210 mlm
U1	450 mcd	560 mcd	1520 mlm
U2	560 mcd	710 mcd	1910 mlm

Forward Voltage Groups

Group Forward Voltage 4) $I_{F} = 20 \text{ mA}$ min.		Forward Voltage ⁴⁾ I _F = 20 mA max.		
4	2.90 V	3.20 V		
5	3.20 V	3.50 V		
6	3.50 V	3.70 V		

Wavelength Groups

Group Dominant Wavelength $^{3)}$ $I_F = 20 \text{ mA}$		Dominant Wavelength ³⁾ I _F = 20 mA
	min.	max.
	$\lambda_{\sf dom}$	$\lambda_{\sf dom}$
3	464 nm	468 nm
4	468 nm	472 nm
5	472 nm	476 nm



Group Name on Label

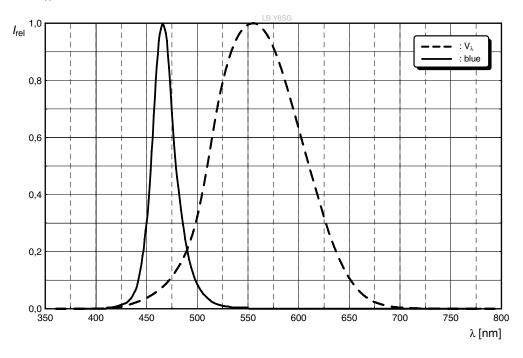
Example: T1-3-4

Brightness	Wavelength	Forward Voltage
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T1 3 4

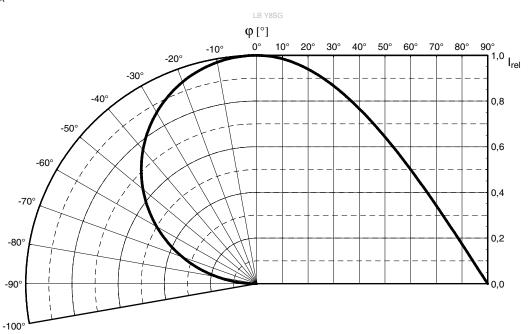
Relative Spectral Emission 7)

 I_{rel} = f (λ); I_F = 20 mA; T_A = 25 °C



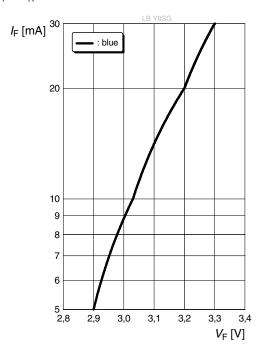
Radiation Characteristics 7)

 $I_{rel} = f(\phi); T_A = 25 °C$



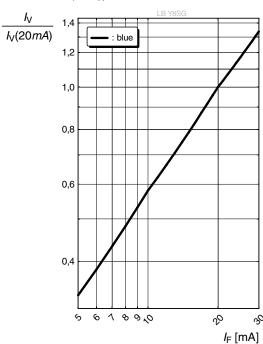
Forward current 7), 8)

$$I_F = f(V_F); T_A = 25 \text{ }^{\circ}\text{C}$$



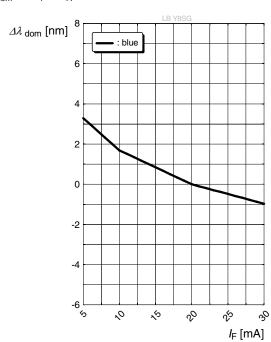
Relative Luminous Intensity 7), 8)

$$I_{V}/I_{V}(20 \text{ mA}) = f(I_{F}); T_{A} = 25 \text{ °C}$$



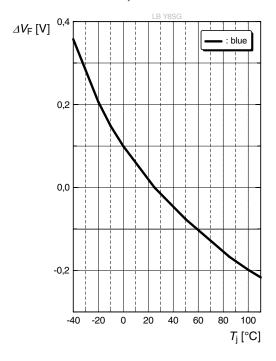
Dominant Wavelength 7)

$$\Delta\lambda_{dom} = f(I_F); T_A = 25 \text{ }^{\circ}\text{C}$$



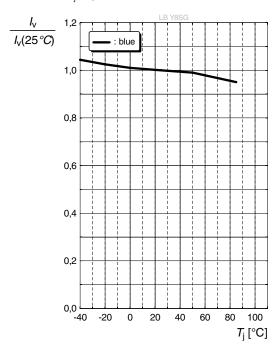
Forward Voltage 7)

$$\Delta V_F = V_F - V_F (25 \ ^{\circ}C) = f(T_j); I_F = 20 \ mA$$



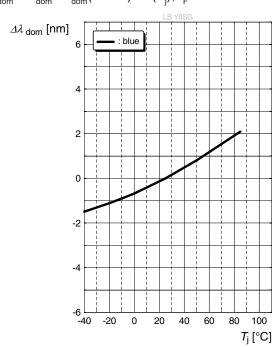
Relative Luminous Intensity 7)

$$I_{v}/I_{v}(25 \text{ °C}) = f(T_{i}); I_{F} = 20 \text{ mA}$$



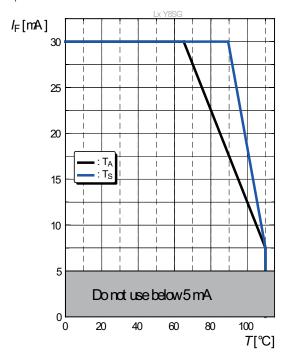
Dominant Wavelength 7)

$$\Delta \lambda_{dom} = \lambda_{dom} - \lambda_{dom} (25 \text{ °C}) = f(T_j); I_F = 20 \text{ mA}$$



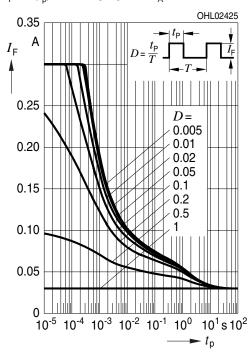
Max. Permissible Forward Current 5)

 $I_F = f(T)$



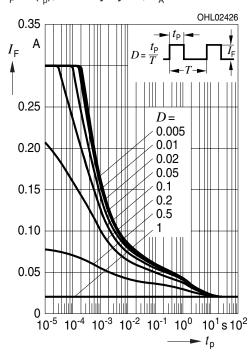
Permissible Pulse Handling Capability

 $I_{_{\rm F}}$ = f(t $_{_{
m p}}$); D: Duty cycle; $T_{_{
m A}}$ = 25 °C

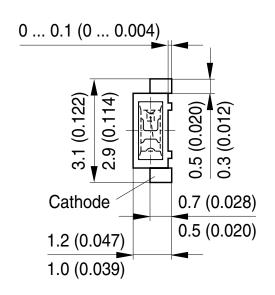


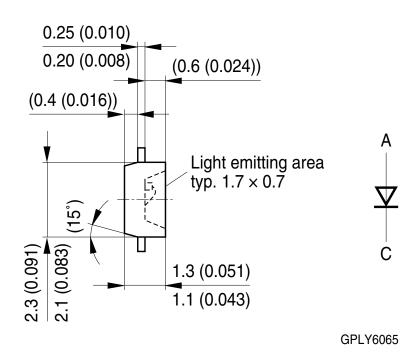
Permissible Pulse Handling Capability

 $I_F = f(t_p)$; D: Duty cycle; $T_A = 85 \, ^{\circ}C$



Dimensional Drawing 9)





Further Information:

Approximate Weight: 6.0 mg

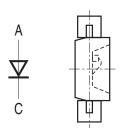
Corrosion test: Class: 1B

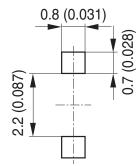
Test condition: 25° C / 75° % RH / 200ppb SO_2 , 200ppb NO_2 , 10ppb H_2 S,

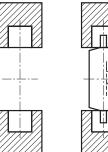
10ppb Cl₂ / 21 days (EN 60068-2-60 (Method 4))

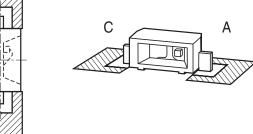
Recommended Solder Pad 9)

Bauteil positioniert Component location on pad









Padgeometrie für verbesserte Wärmeableitung

Paddesign for improved heat dissipation

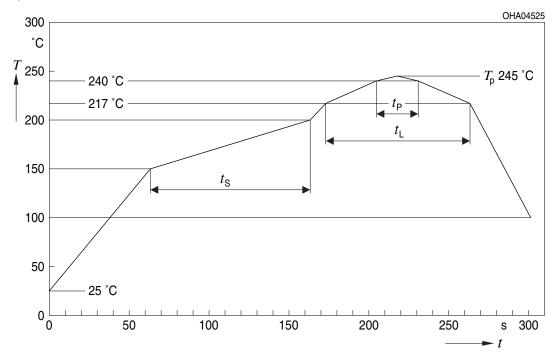
Lötstopplack Solder resist

OHPY1316

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.

Reflow Soldering Profile

Product complies to MSL Level 4 acc. to JEDEC J-STD-020E

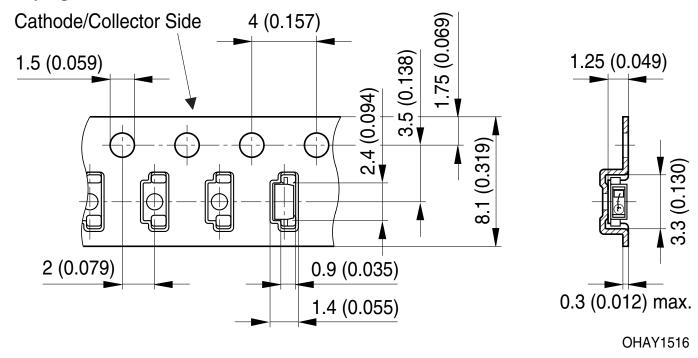


Profile Feature	Symbol	Pb	Pb-Free (SnAgCu) Assembly			
		Minimum	Recommendation	Maximum		
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s	
Time t_s T_{Smin} to T_{Smax}	t _s	60	100	120	S	
Ramp-up rate to peak $^{*)}$ T _{Smax} to T _P			2	3	K/s	
Liquidus temperature	T_{L}		217		°C	
Time above liquidus temperature	$t_{\scriptscriptstyle L}$		80	100	S	
Peak temperature	T_{P}		245	260	°C	
Time within 5 °C of the specified peak temperature T _p - 5 K	t _P	10	20	30	S	
Ramp-down rate* T _P to 100 °C			3	6	K/s	
Time 25 °C to T _P				480	S	

All temperatures refer to the center of the package, measured on the top of the component

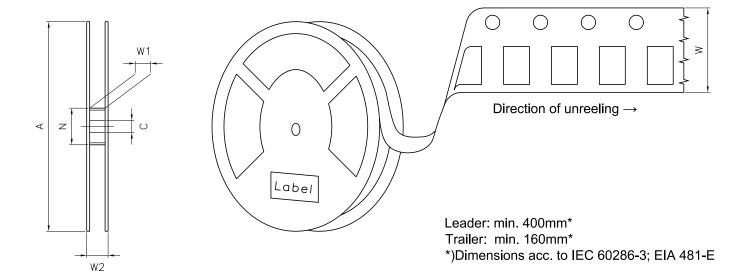
^{*} slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

Taping 9)





Tape and Reel 10)

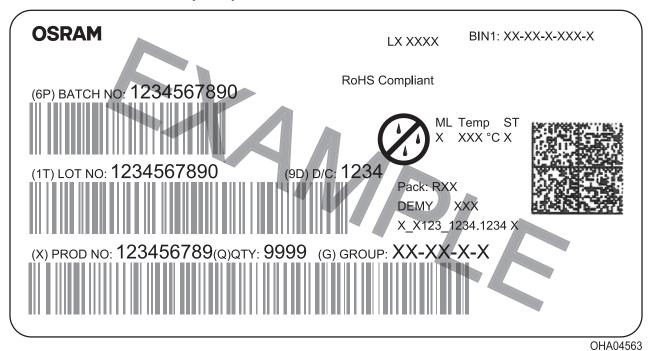


Reel Dimensions

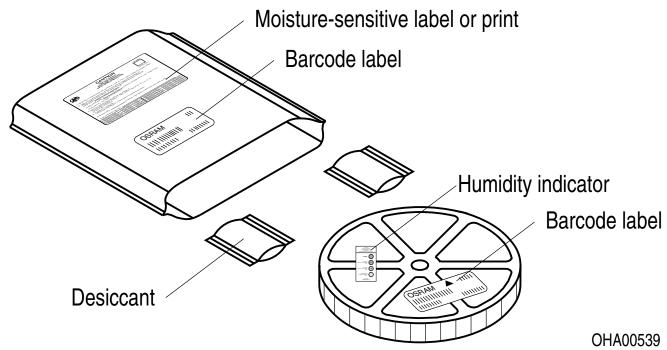
Α	W		N_{\min}	$W_{_1}$		$W_{2\mathrm{max}}$	Pieces per PU
180 mm		8 + 0.3 / - 0.1 mm	60 mm		8.4 + 2 mm	14.4 mm	3000
330 mm		8 + 0.3 / - 0.1 mm	60 mm		8.4 + 2 mm	14.4 mm	10000



Barcode-Product-Label (BPL)



Dry Packing Process and Materials 9)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit https://ams-osram.com/support/application-notes

Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on our website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.

Glossary

- Brightness: Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±8 % and an expanded uncertainty of ±11 % (acc. to GUM with a coverage factor of k = 3).
- Reverse Operation: This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- Wavelength: The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of ±0.5 nm and an expanded uncertainty of ±1 nm (acc. to GUM with a coverage factor of k = 3).
- Forward Voltage: The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of ± 0.05 V and an expanded uncertainty of ± 0.1 V (acc. to GUM with a coverage factor of k = 3).
- ⁵⁾ **Thermal Resistance:** Rth max is based on statistic values (6σ) used for Derating.
- ⁶⁾ Thermal Resistance: RthJA results from mounting on PC board FR 4 (pad size 16 mm² per pad)
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- ⁸⁾ Characteristic curve: In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- ¹⁰⁾ Tape and Reel: All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



Revision History			
Version	Date	Change	
1.5	2023-08-30	New Layout Applications Discontinued	

Discontinued



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